



# Electronic Filing System (EFS) Data

## Electronic Patent Application Submission

### USPTO Use Only

EFS ID: 57017  
Application ID: 10706468   
Title of Invention: SEMICONDUCTOR PACKAGE  
WITH CHAMFERED CORNERS  
AND METHOD OF  
MANUFACTURING THE SAME  
First Named Inventor: Sung Yang  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2003-11-12  
Effective Receipt Date: 2004-03-12  
Submission Type: Information Disclosure Statement  
Filing Type:  
Confirmation number: 6744  
Attorney Docket Number: AMKOR095A

Total Fees Authorized:

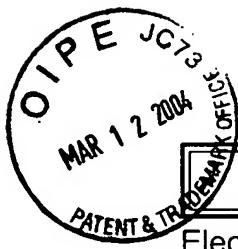
Digital Certificate Holder: cn=Mark B. Garred,ou=Registered Attorneys,ou=Patent and Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US  
Certificate Message Digest: ead68308542404fa914f52adfa8606bf58d7639f



## TRANSMITTAL

Electronic Version v1.1  
Stylesheet Version v1.1.0

Title of Invention	SEMICONDUCTOR PACKAGE WITH CHAMFERED CORNERS AND METHOD OF MANUFACTURING THE SAME	
Application Number:	10/706468	
Date:	2003-11-12	
First Named Applicant:	Sung Jin Yang	
Confirmation Number:	6744	
Attorney Docket Number:	AMKOR095A	
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Submitted by:	Elec. Sign.	Sign. Capacity
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney
Documents being submitted us-ids	Files ids3-usidst.xml us-ids.dtd us-ids.xsl	
Comments		



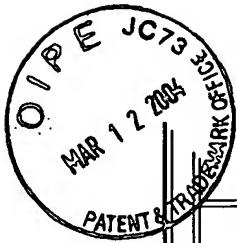
## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18  
Stylesheet Version v18.0

Title of Invention	SEMICONDUCTOR PACKAGE WITH CHAMFERED CORNERS AND METHOD OF MANUFACTURING THE SAME						
Application Number:	10/706468						
Confirmation Number:	6744						
First Named Applicant:	Sung Yang						
Attorney Docket Number:	AMKOR095A						
Art Unit:	2811						
Search string:	( 5640047 or 5639990 or 5641997 or 5644169 or 5643433 or 5646831 or 5650663 or 5661088 or 5665996 or 5673479 or 5683806 or 5689135 or 5696666 or 5701034 or 5703407 or 5710064 or 5724233 or 5723899 or 5736432 or 5745984 or 5753977 or 5753532 or 5766972 or 5770888 or 5776798 or 5783861 or 5801440 or 5814884 or 5814883 or 5814881 or 5814877 or 5818105 or 5817540 or 5821615 or 5821457 or 5835988 or 5834830 or 5844306 or 5856911 or 5859471 or 5866939 or 5871782 or 5874784 or 5877043 or 5886398 or 5886397 or 5894108 or 5897339 or 5900676 or 5903050 ).pn.						
US Patent Documents							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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Signature

Examiner Name	Date